Vishay Siliconix



Top View

# N-Channel 150 V (D-S) 175 °C MOSFET

# PowerPAK® SO-8DC

PRODUCT SUMMARY	
V <sub>DS</sub> (V)	150
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0088
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.010
Q <sub>g</sub> typ. (nC)	24.5
I <sub>D</sub> (A)	78
Configuration	Single

**Bottom View** 

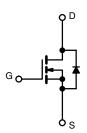
### **FEATURES**

- TrenchFET® Gen V power MOSFET
- Very low R<sub>DS</sub> Q<sub>g</sub> figure-of-merit (FOM)
- $\bullet$  Tuned for the lowest  $R_{DS}$   $Q_{oss}$  FOM
- 100 % R<sub>a</sub> and UIS tested
- · Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

# HALOGEN **FREE**

### **APPLICATIONS**

- · Synchronous rectification
- · Primary side switch
- DC/DC converters
- · OR-ing and hot swap switch
- Power supplies
- · Motor drive control
- · Battery management



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8DC
Lead (Pb)-free and halogen-free	SiDR578EP-T1-RE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	150	V	
Gate-source voltage		V <sub>GS</sub>	± 20		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		78 <sup>a</sup>		
	T <sub>C</sub> = 70 °C	Т. Г	65 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	l <sub>D</sub>	17.4 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	14.5 <sup>b, c</sup>	•	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	200	Α	
	T <sub>C</sub> = 25 °C		136		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	ls –	6.8 <sup>b, c</sup>		
Single pulse avalanche current	. 0.1!!	I <sub>AS</sub>	30		
Single pulse avalanche energy L = 0.1 m		E <sub>AS</sub>	45	mJ	
	T <sub>C</sub> = 25 °C		150		
Maximum power dissipation	T <sub>C</sub> = 70 °C	1 , [	105	10/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	7.5 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C	1	5.25 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175		
Soldering recommendations (peak temperature) d, e			260	°C	

### **Notes**

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

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THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient a, b	t ≤ 10 s	$R_{thJA}$	15	20	
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	0.8	1	°C/W
Maximum junction-to-case (source)	Steady state	$R_{thJC}$	1.1	1.4	

### **Notes**

- a. Surface mounted on 1" x 1" FR4 board
- b. Maximum under steady state conditions is 54 °C/W

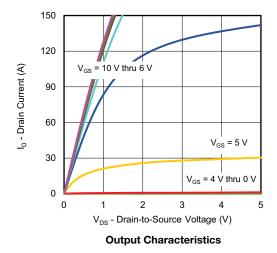
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•	•			
Drain-source breakdown voltage	$V_{DS}$	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	150	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	108	-		
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-7.0	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	-	4	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	100	nA	
7	I <sub>DSS</sub>	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V	-	-	1	μА	
Zero gate voltage drain current		V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	15		
	_	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	0.0073	0.0088	_	
Drain-source on-state resistance a	R <sub>DS(on)</sub>	V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 20 A	-	0.00825	0.010	Ω	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_D = 20 \text{ A}$	-	62	-	S	
Dynamic <sup>b</sup>	0.0	30 . 5				I	
Input capacitance	C <sub>iss</sub>		-	2540	-	pF	
Output capacitance	Coss	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	325	-		
Reverse transfer capacitance	C <sub>rss</sub>	-		6.6	-	1	
-		$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	32.5	49		
Total gate charge	Qg	26 4 7 46 4 7 2	-	24.5	37		
Gate-source charge	Q <sub>as</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 7.5 \text{ V}, I_{D} = 20 \text{ A}$	-	15.3	-	nC	
Gate-drain charge	Q <sub>gd</sub>	V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 20 A		3.1	-		
Output charge	Q <sub>oss</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}$	-	105	-	1	
Gate resistance		f = 1 MHz	0.5	1.35	2.3	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	16	32		
Rise time	` ′	$V_{DD} = 75 \text{ V } \text{ B}_1 = 3.75 \text{ O } \text{ In } \approx 20 \text{ A}$	-	22	44		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_q = 1 \Omega$	-	23	46		
Fall time	t <sub>f</sub>	-	-	23	46		
Turn-on delay time	t <sub>d(on)</sub>		-	18	36	ns	
Rise time		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		68	136		
Turn-off delay time	t <sub>d(off)</sub>		-	21	42	=	
Fall time	t <sub>f</sub>	Ü	-	24	48	-	
<b>Drain-Source Body Diode Characterist</b>	· · ·						
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	94		
Pulse diode forward current	I <sub>SM</sub>	<u> </u>	-	<u> </u>	200	Α	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V	-	0.75	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>	<i>5</i> , 45	-	85	170	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_E = 20 \text{ A. di/dt} = 100 \text{ A/us}$	-	200	400	nC	
Reverse recovery fall time	t <sub>a</sub>	I <sub>F</sub> = 20 A, di/dt = 100 A/μs, - T <sub>J</sub> = 25 °C -		65	-		
Reverse recovery rise time	t <sub>b</sub>		_	20	_	ns	

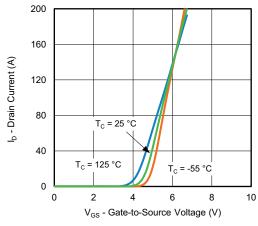
### Notes

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

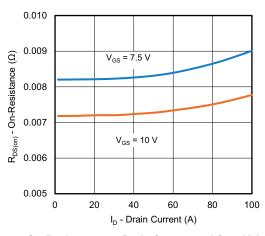
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

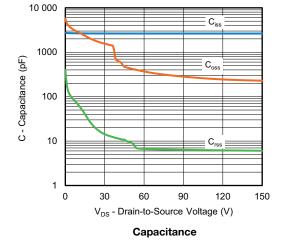




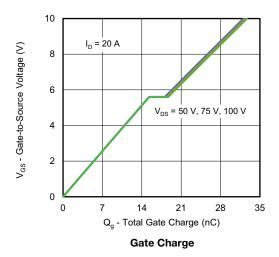


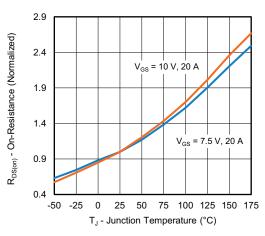
**Transfer Characteristics** 





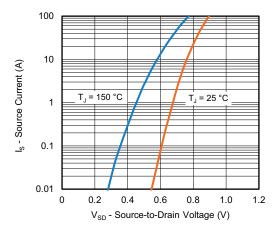
On-Resistance vs. Drain Current and Gate Voltage



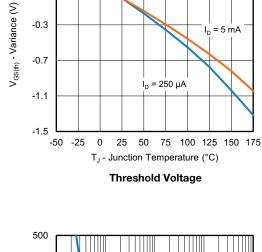


On-Resistance vs. Junction Temperature



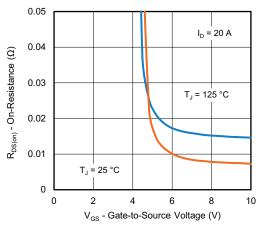


Source-Drain Diode Forward Voltage

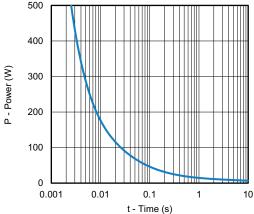


0.5

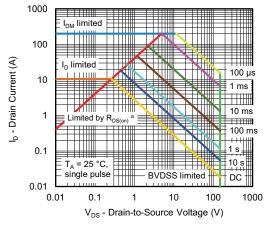
0.1



On-Resistance vs. Gate-to-Source Voltage

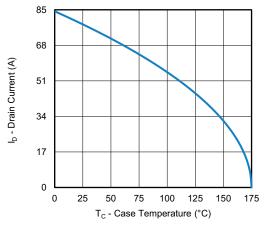


Single Pulse Power, Junction-to-Ambient

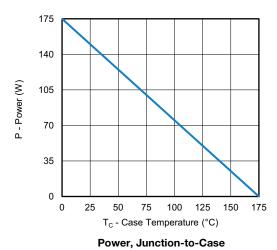


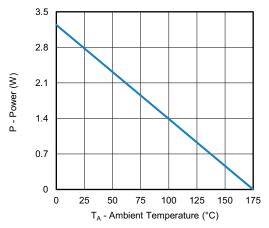
Safe Operating Area, Junction-to-Ambient





Current Derating a



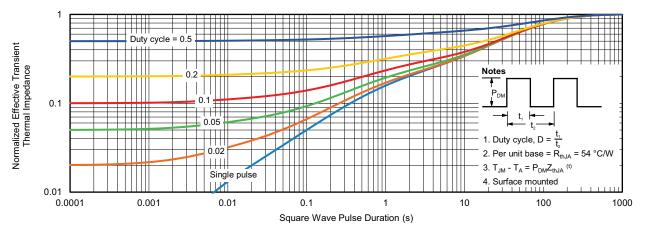


Power, Junction-to-Ambient

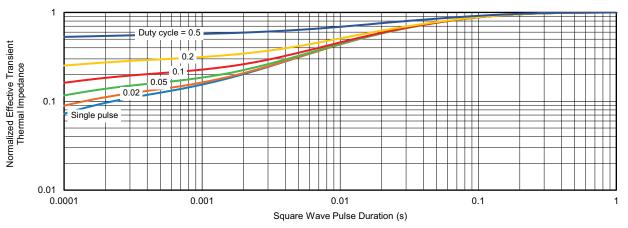
### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



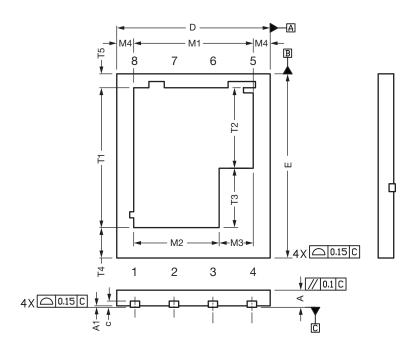
Normalized Thermal Transient Impedance, Junction-to-Case

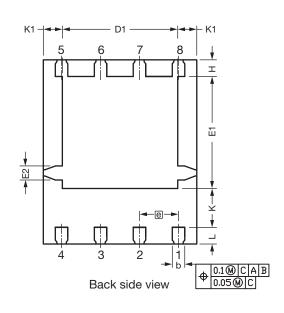
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DWG: 6048

# PowerPAK® SO-8 Double Cooling Case Outline





DIM.	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.51	0.56	0.61	0.020	0.022	0.024	
A1	0.00	0.02	0.05	0.000	0.001	0.002	
b	0.36	0.41	0.46	0.014	0.016	0.018	
С	0.15	0.20	0.25	0.006	0.008	0.010	
D	4.90	5.00	5.10	0.193	0.197	0.201	
D1	3.71	3.76	3.81	0.146	0.148	0.150	
е		1.27 BSC			0.050 BSC		
Е	5.90	6.00	6.10	0.232	0.236	0.240	
E1	3.60	3.65	3.70	0.142	0.144	0.146	
E2	0.46 typ.			0.018 typ.			
Н	0.49	0.54	0.59	0.019	0.021	0.023	
K	1.22	1.27	1.32	0.048	0.050	0.052	
K1		0.64 typ.		0.025 typ.			
L	0.49	0.54	0.59	0.019	0.021	0.023	
M1	3.8	3.90	4.00	0.150	0.154	0.158	
M2	2.69	2.79	2.89	0.106	0.110	0.114	
МЗ	1.01	1.11	1.21	0.040	0.044	0.048	
M4		0.56 typ.		0.022 typ.			
N		8		8			
T1	4.46	4.56	4.66	0.176	0.180	0.184	
T2	2.53	2.63	2.73	0.100	0.104	0.108	
T3	1.83	1.93	2.03	0.072	0.076	0.080	
T4	0.97 typ.			0.038 typ.			
T5	0.48 typ.			0.019 typ.			

Revison: 29-Jul-2024 1 Document Number: 75846



### RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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